SCOPE:

This specification applies to the Pb Free high current type SMD coupled inductors for MSI-181108CP-R050M-H-VT

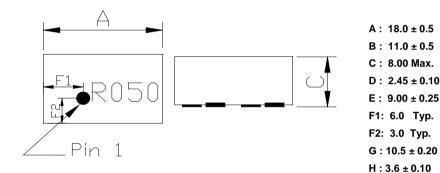
"This device is licensed for use only when incorporated within a voltage regulator or converter employing power regulating devices manufactured or designed by Volterra Semiconductor Corp. No license is granted expressly or by implication to use this device with power regulating devices manufactured or designed by any company other than Volterra."

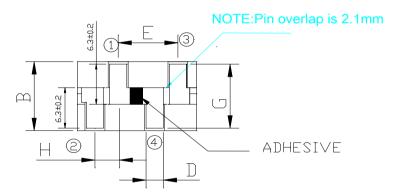
PRODUCT INDENTIFICATION

MSI - 181108CP - R050 M - H - VT ① ② ③ ④ ⑤

- ① Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code
- **⑤ Inner Control Code**

(1) SHAPES AND DIMENSIONS





(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L: HP 4285A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

(3)-2 Storage temperature range $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$



mm

mm

mm

mm

mm

mm

mm

mm

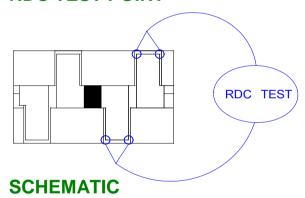
mm

TABLE

MAGLAYERS PT/NO :		MSI-181108CP-R050M-H-VT			
OCL (nH)	Current (A)	@ 25℃	@ 85℃	@ 105℃	
	0A	200 Min.			
	15A	200 Min.			
	20A	200 Min.	190 Min.	180 Min.	
	23A	_	_	100 Min.	
	25A	150 Min.	120 Min.	_	
LK (nH)	0A	50±20%			
	110A	40 Min.			
RDC(mΩ)		0.29±10%			
Irms	50A	Based on temperature rise (△T: 40°C TYP.)			

^{*}Open Circuit Inductance(OCL)

RDC TEST POINT







^{*}Test Frequency: 1MHz/0.1Vrms, 0.0Adc

^{*}The specs (Lk at 0A, and OCL at 0A and 25A) are guaranteed at room temp as tested in production and other parameters are guaranteed by design.

(4) RELIABILITY TEST METHOD

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^\circ\!\!\!\mathrm{C}$,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≦±10%.

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		in figure 1 and a load applied unitil the figure in the arrow			
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
	no mechanical	PCB dimension shall the page 7/9			
	damage or elec-	F(Pressurization)			
	trical damage.	\Box			
		R5 45±2 45±2			
		10 20 R340			
		PRESSURE ROD figure-1			

MECHANICAL

TEST ITEM	SPECIFICATION				
Vibration	∆L/Lo≦±5%	△L/Lo≦±5% The sample shall be soldered onto the printed circuit board			
		and when a vibration having an amplitude of 1.52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
	damage.	(A total of 6 hours)			
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
	More than 90%	over the whole of the sample before hard, the sample shall			
		then be preheated for about 2 minutes in a temperature of			
		130~150℃ and after it has been immersed to a depth 0.5mm below for 3±0.2 seconds fully in molten solder M705 with a temperature of 245±5℃. More than 90% of the electrode sections shall be couered			
		with new solder smoothly when the sample is taken out of			
		the solder bath.			
Resistance to	There shall be	Temperature profile of reflow soldering			
Soldering heat	no damage or	soldering			
(reflow soldering)	problems.	(Peak temperature 260±3°C 10 sec)			
		Pre-heating (Peak temperature 260±3°C 10 sec) 30 sec Min (230+0°C) Slow cooling (Stored at room			
		© 200 / 30 sec Min			
		(230 ⁺⁰ °C)			
		Slow cooling			
		1 / I temperature)			
		50/			
		2 min sec. 2 min. or more			
		sec. 2 min. or more			
1					
		The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time.			
1		The specimen shall be stored at standard atmospheric conditions			
		for 1 hour, after which the measurement shall be made.			
1					



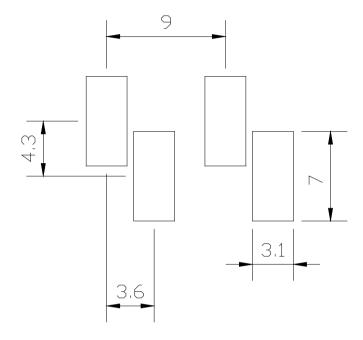
ENVIROMENT CHARACTERISTICS

TEST ITEM	SPECIFICATION					
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with				
storage		a temperature of 125℃ and a normal humidity.				
	There shall be	Upon completion of the measurement shall be made after the				
	no mechanical	sample has been left in a normal temperature and normal				
	damage.	humidity for 1 hour.				
Low temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmosphere with				
storage		a tempe	rature	of -40±3℃.		
	There shall be	Upon completion of the test, the measurement shall be made				ade
	no mechanical	after the sample has been left in a normal temperature and				t
	damage.	normal	humid	ity for 1 hour.		
Change of	∆L/Lo≦±5%	The san	nple sł	nall be subject to 5 con	tinuos cycles, such a	s shown
temperature		in the ta	ble 2 l	pelow and then it shall	be subjected to stand	dard
	There shall be	stmospl	heric c	conditions for 1 hour, a	fter which measurem	ent
	no other dama-	shall be	made			
	ge of problems					
				table 2		_
				Temperature	Duration	
			1	-40±3°C	30 min.	
			·	(Themostat No.1)	30 111111.	
			2	Standard	No.1→No.2	
			_	atmospheric		
			3	125±2 ℃	30 min.	
				(Themostat No.2)		
			4	Standard	No.2→No.1	
				atmospheric		
Moisture storage	∆L/Lo≦±5%	The san	nple sl	nall be left for 96±4 hou	ırs in a temperature o	f
J		40±2°C and a humidity(RH) of 90∼95%.				
	There shall be Upon completion of the test, the measuremen					ade
	no mechanical	after the sample has been left in a normal temperature and normal humidity more than 1 hour.				
	damage.					
Test conditions :		1		<u>-</u>		
	mple shall be reflow	soldered	d onto	the printed circuit boa	rd in every test.	



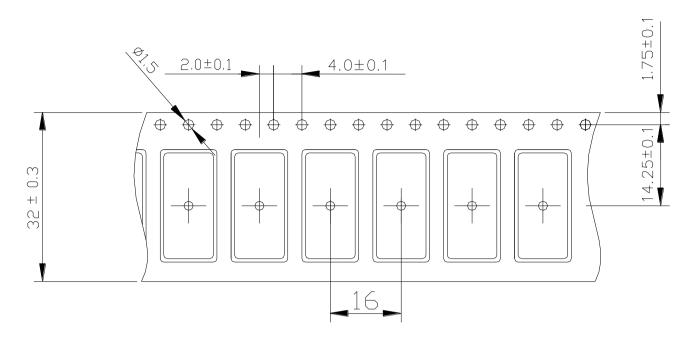
(5) LAND DIMENSION (Ref.)

(5)-1 LAND PATTERN DIMENSIONS(mm)

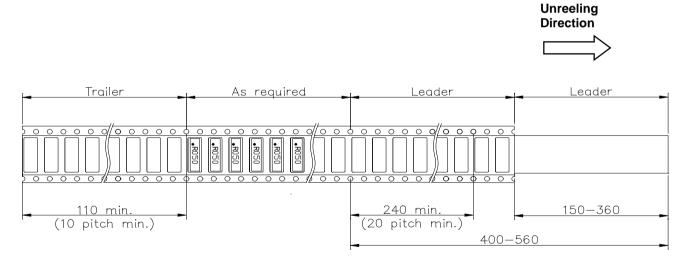


(6) PACKAGING

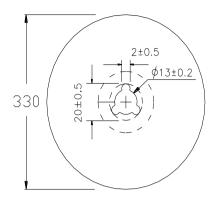
(6)-1 CARRIER TAPE DIMENSIONS (mm)

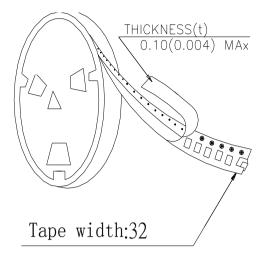


(6)-2 TAPING DIMENSIONS (mm)



(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

350 pcs/Reel

The products are packaged so that no damage will be sustained.

Please note that the contents may change without any prior notice due to reasons such as upgrading.

